

Optimization and Fully-Distributed Analysis of Single-Pole Single-Throw Traveling Wave Switches at Millimeter Wave Frequency Band

Hamed Khoshniyat

Electrical Engineering Department
Amirkabir University of Technology
Tehran, Iran

hkhoshniyat@aut.ac.ir

Gholamreza Moradi

Electrical Engineering Department
Amirkabir University of Technology
Tehran, Iran

ghmoradi@aut.ac.ir

Abdolali Abdipour

Electrical Engineering Department
Amirkabir University of Technology
Tehran, Iran

abdipour@aut.ac.ir

Kambiz Afrooz

Electrical Engineering Department
Amirkabir University of Technology
Tehran, Iran

kambiz.afrooz@aut.ac.ir

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Abstract—In this paper, a fully distributed model for a single pole single throw traveling wave switch is introduced and important parameters of the switch such as insertion loss, isolation, and reflection coefficient are presented based on the lossy transmission line model of switch. The results of fully distributed model are compared with the semi-distributed model's results and have good agreement with them. By applying the fully distributed model and calculating various switch's parameters as a function of the switch length and operating frequency, the optimum switch length and operating frequency are obtained versus the parameters of switch, especially the reflection coefficient and isolation in OFF and ON conditions.

Keywords—Distributed structure, single pole single throw (SPST) switch, traveling wave switch (TWSW), lossy transmission line model, semi-distributed model.

I. INTRODUCTION

Nowadays, the demand for millimeter wave applications such as high-speed wireless LAN systems, radar systems is growing rapidly and also there is a huge demand for microwave circuits to operate at higher and higher frequency to achieve larger bandwidth. On the other hand, there has been an enlarged demand for microwave integrated circuit application at higher frequencies caused by low fabrication cost and better operation at further frequencies.

In communication and radar systems, switches play a fundamental role to control the flow of RF signal in transmitters and receivers. In the above-mentioned applications, broadband switches with high power transfer capability and high switching speed, have a serious duty in realization of low-cost communication systems.

Given the wide range of applications involving millimeter wave circuits in high speed communication and the important role played by distributed switches in communication systems, there has been a huge amount of research carried out on various microwave switches to improve switch performance. Toward this

end, there has been some research to improve parameters such as insertion loss and isolation. In multiple millimeter wave applications, various switch structures are reported in the literatures [1]-[6].

In [1], performance of a single pole single throw traveling wave switch is analyzed with a lossy transmission line model. A single pole double throw traveling wave switch using fully distributed FET has been developed and discussed in [2]. [3] indicates a switch structure, which has a shunt structure in connection with a quarter wavelength transformer. The switches designed with this type of structure have an insertion loss less than 1.5 dB and isolation greater than 25 dB in the frequency range from 59 GHz to 61 GHz. Another structure involves a series FET in parallel with an inductor. Such a switch has an insertion loss of 1.6 dB and an isolation of 20 dB at 94 GHz [4]. The parallel LC resonance structure, a capacitive stub and an inductor line, is another microwave switch structure. A switch made in this structure has an insertion loss of 3.9 dB and an isolation of 41 dB at 60 GHz [5]. Yet another switch circuit has the series-shunt structure using the ohmic electrode sharing technology (OEST). Such a switch has an isolation of more than 20.6 dB and an insertion loss of less than 1.64 dB; these structures have been presented and discussed in [6].

In this paper, first a fully distributed model of a single pole single throw traveling wave switch is introduced. The results of fully distributed model are compared with the sliced model's results. These results have a good agreement with each other. By adjusting the length of the switch, the optimum length to gain proper insertion loss, isolation, reflection coefficient and wide bandwidth is presented and discussed.

II. CIRCUIT STRUCTURE

The schematic of a Single Pole Single Throw (SPST) Traveling Wave Switch (TWSW) is shown in Fig. 1. The gate voltage (V_g) controls the transfer of signal through the drain transmission line. In distributed switches, the switch's length is comparable to the wavelength of the maximum frequency of the circuit, so the wave transmission in this structure cannot be ignored. Therefore, lump modeling cannot analyze distributed structures. Instead, distributed modeling should be applied for the analysis of these elements.

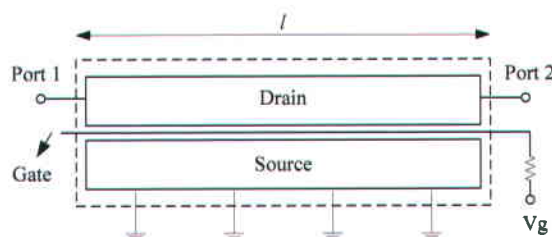


Fig. 1. Schematic of Single Pole Single Throw (SPST) Traveling Wave Switch (TWSW).

In semi-distributed modeling, the device is divided into N slices, which lump modeling is reliable for each segment. If the number of slices approaches infinity, then the semi-distributed analysis changes to fully-

distributed modeling. The equivalent slice model of TWSW is shown in Fig. 2.

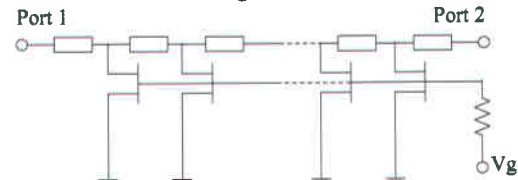


Fig. 2. Slice or semi-distributed model of TWSW.

III. LOSSY TRANSMISSION LINE MODEL

In distributed model of switch, by using the small-signal equivalent circuit as seen from drain terminal based on the FET model and the transmission line model of drain terminal, based on the control voltage (V_g) applied to gate, the lossy transmission line model of switch is resulted (Fig. 3).

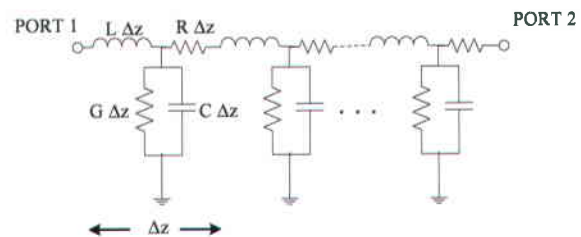


Fig. 3. The lossy transmission line model of TWSW.

Parameters of the transmission line model are combination of the equivalent admittance of the FET which is seen from Drain terminal and Drain TL parameters. The primary parameters of TL model are expressed as:

$$\begin{cases} R = R_{TL} \\ L = L_{TL} \\ C = C_{TL} + C_{FET}(V_g) \\ G = G_{FET}(V_g) \end{cases} \quad (1)$$

The secondary parameters of the transmission line, i.e., γ and Z , are calculated based on the primary parameters and are represented as [2]:

$$\gamma = \alpha + j\beta = \sqrt{(R + j\omega L)(G + j\omega C)} \quad (2)$$

$$Z = \sqrt{\frac{R + j\omega L}{G + j\omega C}} \quad (3)$$

Therefore, according to the controlling voltage (V_g), the secondary parameters of the switch are derived as:

$$\begin{aligned} \gamma &= \alpha + j\beta \\ &= \sqrt{(R_{TL} + j\omega L_{TL})(G_{FET}(V_g) + j\omega(C_{TL} + C_{FET}(V_g)))} \end{aligned} \quad (4)$$

$$Z = \sqrt{\frac{R_{TL} + j\omega L_{TL}}{G_{FET}(V_g) + j\omega(C_{TL} + C_{FET}(V_g))}} \quad (5)$$

In these equations, R_{TL} , L_{TL} and C_{TL} are the series resistance and inductance and shunt capacitance of the drain transmission line per unit length, C_{FET} and G_{FET} are the shunt capacitance and conductance of the equivalent admittance of FET seen from Drain per unit length respectively. The values of C_{FET} and G_{FET} are dependent on status of the switch and controlling

voltage. The series resistance R_{TL} is caused by the skin effect and is proportional to the square of frequency. R_{TL} can be expressed as [1]:

$$R_{TL} = \chi \sqrt{f} \quad (6)$$

The lossy transmission line model of the switch can be represented as a two port network (Fig.4).

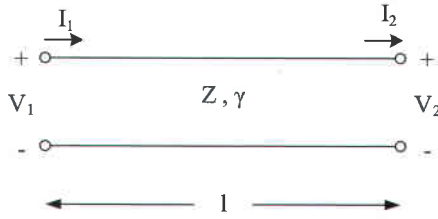


Fig. 4. Consider TWSW as a two port network.

The transmission matrix (ABCD Matrix) of switch is shown as:

$$\begin{bmatrix} A & B \\ C & D \end{bmatrix} = \begin{bmatrix} \cosh \gamma l & Z \sinh \gamma l \\ \frac{1}{Z} \sinh \gamma l & \cosh \gamma l \end{bmatrix} \quad (7)$$

Using the ABCD Matrix and the convergence of ABCD to scattering matrix, the S-parameters of the switch are derived as [2]:

$$S_{11} = \frac{(Z^2 - Z_0^2) \sinh \gamma l}{2ZZ_0 \cosh \gamma l + (Z^2 + Z_0^2) \sinh \gamma l} \quad (8)$$

$$S_{21} = \frac{2ZZ_0}{2ZZ_0 \cosh \gamma l + (Z^2 + Z_0^2) \sinh \gamma l} \quad (9)$$

As the values of C and G change in the ON and OFF states, the secondary parameters γ and Z change; thus the scattering parameters are dependent on the status of switch. The FET parameters, i.e. C_{FET} and G_{FET} are determined based on the Curtice 2 equivalent model of FET. The nonlinear elements of this model are expressed as [7]:

$$I_{ds}(V_{gs}, V_{ds}) = \beta (V_{gs} - V_{T0})^2 (1 + \lambda V_{ds}) \tanh(\alpha V_{ds})$$

$$C_{gs} = C_{gs0} \times \left(1 - \frac{V_{gs}}{V_{bi}}\right)^{-1/2} \quad (10)$$

$$C_{gd} = C_{gd0} \times \left(1 - \frac{V_{gd}}{V_{bi}}\right)^{-1/2}$$

The parameters of Curtice 2 model of FET for 100 μ m TWSW are shown in Table I.

Table I
Curtice 2 model's parameters for 100 μ m TWSW

Parameter	Value
β	0.0162 A/V ²
α	1.3 V ⁻¹
λ	0 V ⁻¹
V_{T0}	-2.35 V
C_{gs0}	12 fF
C_{gd0}	5.915 fF
C_{ds}	17.745 fF
V_{bi}	0.85 V

The diagrams of G_{FET} and C_{FET} versus V_{gs} for 100 μ m TWSW are shown in Figs. 5 and 6. The status

of switch is controlled by the applying gate voltage. The switch transfers the signal through drain TL in ON state. In the OFF state, the switch behaves as short circuit and reflected the input signal and prevents from transmission of RF signal.

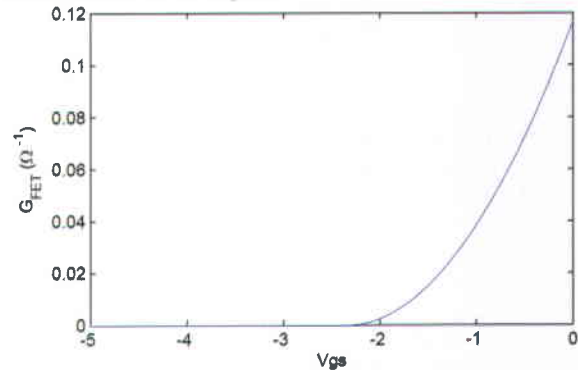


Fig. 5. G_{FET} versus V_{gs} for 100 μ m TWSW.

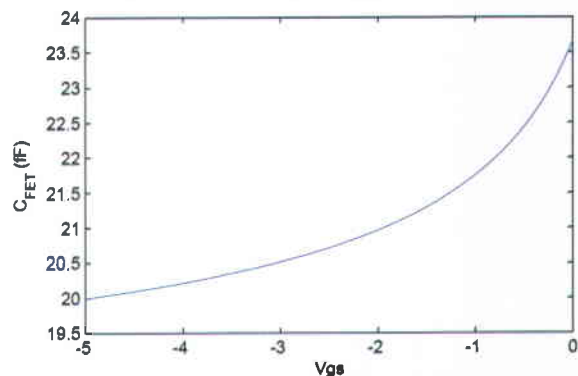


Fig. 6. C_{FET} versus V_{gs} for 100 μ m TWSW.

The parameters of a Drain's transmission line for 100 μ m TWSW is listed in Table II [1]. Using the parameter values for 100 μ m FET, the values of R, L, C and G per unit length are calculated.

Table II
Drain's TL parameters for 100 μ m TWSW

Parameter	Value
χ	$3.15 \times 10^{-6} \Omega/\text{Hz}^{1/2}$
L_{TL}	40 pH
C_{TL}	7 fF

IV. ANALYSIS OF LOSSY TRANSMISSION LINE MODEL

In this section, by using the scattering parameters S_{11} and S_{21} , the behavior of a 600 μ m TWSW is studied versus control voltage and operating frequency. These parameters are shown in Figs. 7 and 8.

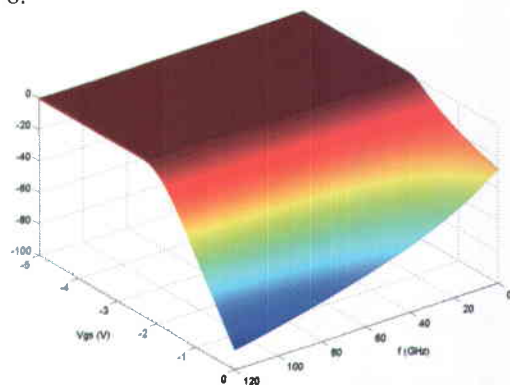


Fig. 7. Calculated S_{21} (dB) for 600 μ m TWSW versus Control Voltage (V_{gs}) and operation frequency.

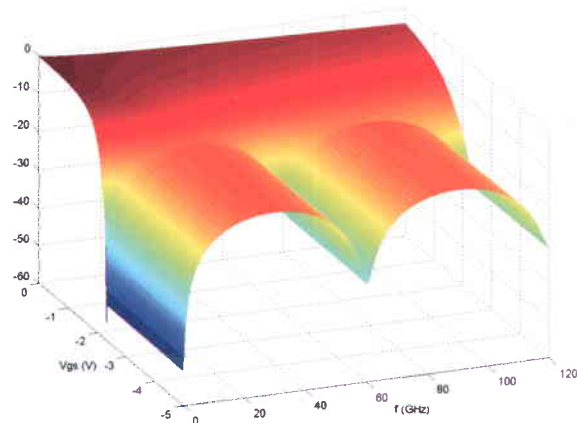


Fig. 8. Calculated S_{11} (dB) for 600 μ m TWSW in various Control Voltage (V_{gs}) and operation frequency.

In Fig. 9, the division of operating area is shown. The domain is divided to ON, OFF and transient regions based on the amplitude of S_{21} (dB) in that regions.

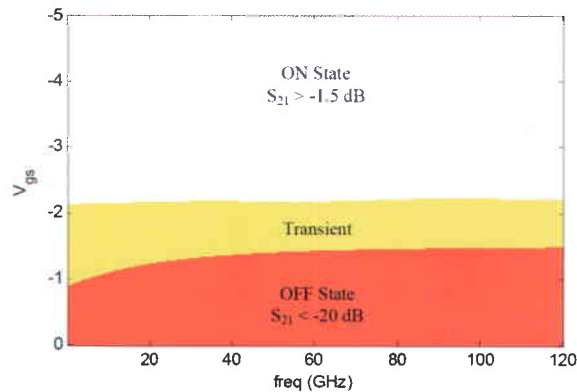


Fig. 9. Defined the ON and OFF region for 600 μ m TWSW based on the S_{21} (dB).

In the ON state, S_{21} (dB) > -1.5dB, the switch passes the signal with low insertion loss, and in the OFF region, S_{21} (dB) < -20dB, the switch isolates the input and output terminates, and prevent the flow of RF signal. In the transient area, the behavior of TL is not suitable to act as a switch and must be prevented from operating in this region, thus the ON and OFF control voltages are selected as far as possible from the transient region, and the control voltage are selected as:

$$\begin{cases} V_{gs}(ON) = -5V \\ V_{gs}(OFF) = 0V \end{cases} \quad (11)$$

According to Figs. 7 and 8, in the ON state, $V_{gs} = -5V$, the signal transfers through the transmission line and reflected signal is low. In the OFF states, $V_{gs} = 0V$, the switch prevents the transfer of signal and behaves like a short circuit and reflected a high ratio of incident signal.

In the next part of this section, the performance of a 600 μ m TWSW is studied in ON and OFF states with fully distributed analysis, by applying the scattering parameters. The results are compared with the semi-distributed analysis of switch to validate. In sliced analysis, the switch structure is dividing into 20 equal slices each with a 30 μ m length. These results are shown in OFF and ON status in Figs. 10 and 11.

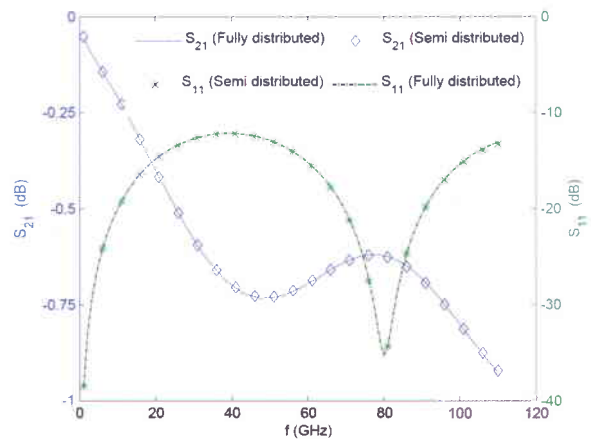


Fig. 10. Calculated insertion loss and reflection coefficient for 600 μ m TWSW in ON state using scattering parameters and sliced modeling.

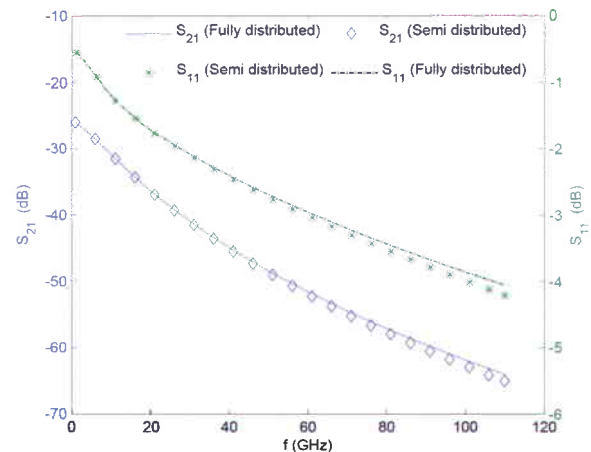


Fig. 11. Calculated isolation and reflection coefficient for 600 μ m TWSW in OFF state using scattering parameters and semi-distributed modeling.

As seen in Figs. 10 and 11, the results of the fully distributed model and sliced model are in close agreement with each other in ON and OFF status and the fully distributed model is validated.

In the last part of this section, the behavior of switch is studied as a function of the length of switch and operating frequency. According to Figs. 12 and 13, in OFF state, the reflection coefficient is better in small length and isolation is closer to desired value in large switch length; therefore, a tradeoff between these parameters needs to be done. As the reflection coefficient changes are negligible, the isolation is chosen as the principal parameters in OFF state.

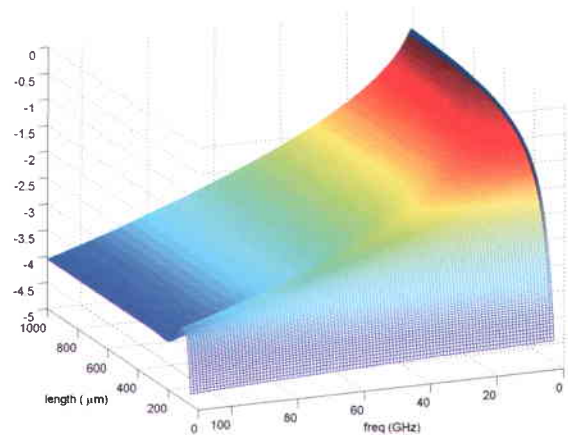
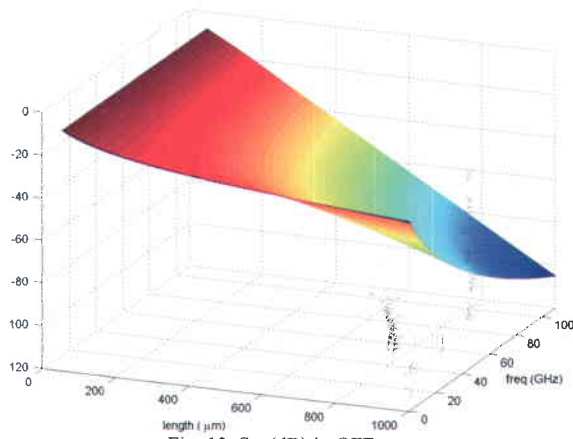
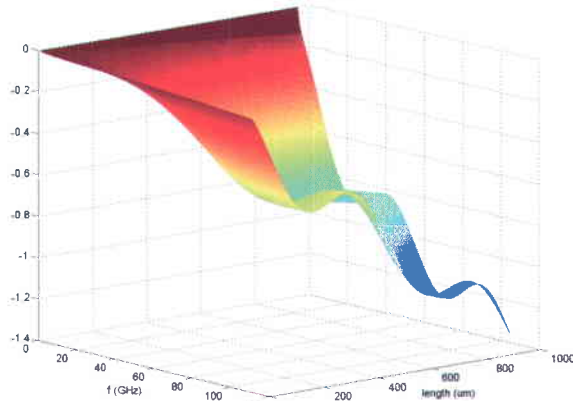
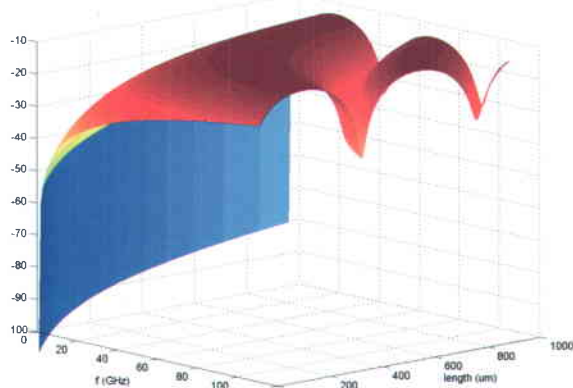


Fig. 12. S_{11} (dB) in OFF state.

Fig. 13. S_{21} (dB) in OFF state.

Figs. 14 and 15, indicate that the insertion loss is satisfactory in the ON state, thus the reflection coefficient is the main parameter in the ON state. Thus, the important parameters in optimization of TWSW are isolation ($S_{21}(\text{OFF})$) and reflection coefficient in ON state ($S_{11}(\text{ON})$).

Fig. 14. S_{21} (dB) in ON state.Fig. 15. S_{11} (dB) in ON state.

V. OPTIMIZATION OF SWITCH PERFORMANCE

The scattering parameters of the switch, i.e., S_{11} and S_{21} , are functions of the length of drain transmission line. In this section, S_{11} and S_{21} are calculated at various frequencies and switch lengths, and the optimum switch length is achieved based on desired isolation and reflection coefficient.

S_{11} and S_{21} as a function of frequency and switch length in OFF and ON states are illustrated in Figs. 12-15. Figs. 16 and 17 indicate the frequency and length domain division based on isolation and reflection

coefficient in the ON state. Fig. 18 displays the composition of two figures.

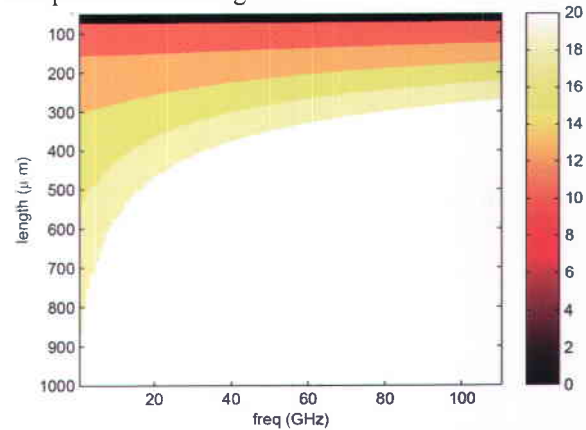
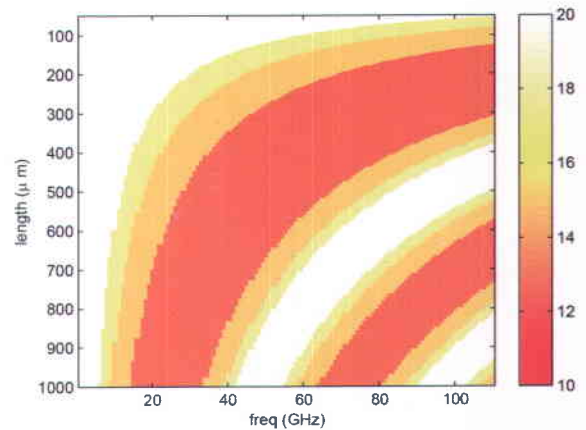
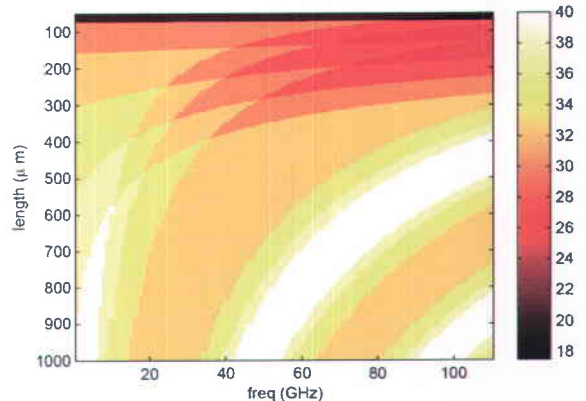
Fig. 16. Division of domain based on S_{21} (OFF).Fig. 17. Division of domain based on S_{11} (OFF).

Fig. 18. The combination of two divisions of domain.

Table III is suggested for optimization. The domain is separated based on the value of $S_{11}(\text{ON})$ and $S_{21}(\text{OFF})$, and finally the region that has the highest value is chosen as the optimum zone.

Table III

The division of domain by mapping the value and weight to the regions, based on $S_{21}(\text{OFF})$ and $S_{11}(\text{ON})$.

Value	S_{21} (OFF)	S_{11} (ON)
20	$S_{21}(\text{OFF}) \leq -30$ dB	$S_{11}(\text{ON}) \leq -20$ dB
17.5	$S_{21}(\text{OFF}) \leq -25$ dB	$S_{11}(\text{ON}) \leq -17$ dB
15	$S_{21}(\text{OFF}) \leq -20$ dB	$S_{11}(\text{ON}) \leq -14$ dB
12.5	$S_{21}(\text{OFF}) \leq -15$ dB	$S_{11}(\text{ON}) \leq -11$ dB
10	$S_{21}(\text{OFF}) \leq -10$ dB	$S_{11}(\text{ON}) \leq -8$ dB
0	$S_{21}(\text{OFF}) \geq -10$ dB	$S_{11}(\text{ON}) \geq -8$ dB

Considering the acceptable range of parameters and the classification of the domain, the optimum region is achieved from Fig. 18. Three light regions have reflection coefficient in ON state less than -20 dB and isolation more than 30 dB, therefore according to operating frequency the best optimum region is chosen. For example, the optimum length of switch to achieve the biggest bandwidth is 800 μm at 60 GHz. The scattering parameters of 800 μm TWSW in ON and OFF states are shown in Figs. 19 and 20.

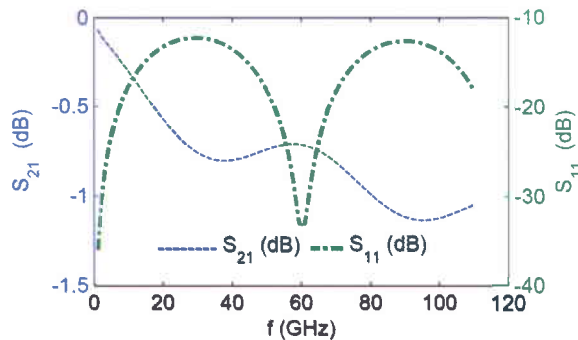


Fig. 19. The insertion loss and reflection coefficient for 800 μm TWSW in ON state.

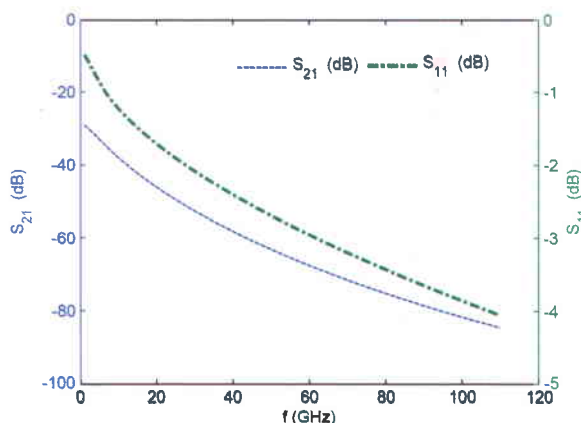


Fig. 20. The isolation and reflection coefficient for 800 μm TWSW in OFF state.

As it can be observed in Figs. 19 and 20, the switch has a small insertion loss in wide frequency range in the ON state and a proper isolation in the OFF state, in which case switch almost does not transfer any signal through drain transmission line and behaves like a short circuit and reflects RF signal. Of course, different considerations in practice decrease this bandwidth, but altogether the distributed structure is ideal for reaching wide bandwidth.

VI. CONCLUSION

With growing operating frequencies and as the switch lengths are becoming comparable with wavelength; lump modeling cannot describe the behavior of structures properly. Therefore, the requirement for fully distributed modeling with consideration of wave transmission in the structure is becoming obvious. Also, because of the wave transmission effects, the operation of the switch is intensely related on the frequency and structure dimensions. Therefore, the effect of distribution, the length of switch has an important effect on the behavior of the system. The switch parameters have been calculated versus frequency and switch length,

and given acceptable values for the parameters, the optimum length of switch has been achieved.

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Hamed Khoshniyat was born in Karaj, Iran, in 1985. He received B.Sc. and M.Sc. degrees from the Amirkabir University of Technology (Tehran Polytechnic), Tehran, Iran, both in electrical engineering, in 2008 and 2010 respectively. He is currently studying the Ph.D. degree in "fields and waves" and a Research

Assistant in the Wave Propagation and Microwave Measurement Laboratory (WPMML) in electrical engineering at Amirkabir University of Technology (Tehran Polytechnic). His current research interests include analysis & modeling of microwave switches, active and passive microwave device and circuits and microwave measurement.



Gholamreza Moradi was born in Shahriar, Iran in 1966. He received his B.Sc. degree in Electrical Communication Engineering from Tehran University, Tehran, Iran in 1989, and the M.Sc. degree in the same field from Iran University of Science and Technology in 1993. He received his Ph.D. degree in Electrical Engineering from Tehran Polytechnic University, Tehran,

Iran in 2002. His main research interests are numerical electromagnetics, antennas, active microwave circuits, mm-wave circuits and systems and microwave measurements. In 2003, he was selected as the exemplary researcher of Iranian Ministry of Road and Transportation. During 1997 till 2006, he was a faculty member at Civil Aviation Technology College, Tehran, Iran. He has published several



papers in the refereed journals and the local and international conferences. Also, he has co-authored four books entitled Communication Transmission Lines, Microwave Engineering, Engineering Mathematics, and Active Transmission Lines (in Persian). The latter was selected as the book of the year of Iran in 2008. He is currently an assistant Professor of Electrical Engineering Department at Amirkabir University of Technology (Tehran Polytechnic), Tehran, Iran.



Abdolali Abdipour was born in Alashtar, Iran, in 1966. He received the B.Sc. degree in electrical engineering from Tehran University, Tehran, Iran, in 1989 the M.Sc. degree in electronics from Limoges University, Limoges, France, in 1992, and the Ph.D. degree in electronic engineering from Paris XI (Orsay) University, Paris, France, in 1996. He was an Assistant Professor

from 1997 to 2002, he was an Associate Professor from 2002 to 2006, and has been a Full Professor since 2006 all at the Department of Electrical Engineering, Amirkabir University of Technology (Tehran Polytechnic), Tehran, Iran. He was the Director of the Microwave/Millimeter Wave Research Laboratory since 1998. He was the Chair of the Department of Electrical Engineering from 2006 to 2009, was the Director of the Radio Communication Center of Excellence (RACE) from 2006 to 2011, and is currently the Director of the Microwave/Millimeter-Wave and Wireless Communication Research Center at Communication Technology and Applied Electromagnetic Institute at Amirkabir University of Technology. He was also selected as the Distinguished Researcher (2009) and the Distinguished Professor (2010) of the Amirkabir University of Technology. He also chaired the first conference on Millimeter Wave and Terahertz Technologies (MMWaTT 2009). He is the author of three books: 1) *Noise in Electronic Communication: Modeling, Analysis and Measurement* (Amirkabir Univ. Press, 2005, in Persian); 2) *Transmission Lines* (Nahre Danesh Press, 2006, in Persian); and 3) *Active Transmission Lines in Electronics and Communications: Modeling and Analysis* (Amirkabir Univ. Press, 2007, in Persian—the top selected book of the year by the Ministry of Culture). He has published more than 212 papers in refereed journals and international conferences. His research interests include wireless communication systems (RF technology and transceivers), RF/microwave/millimeter-wave circuit and system design, electromagnetic (EM) modeling of active devices and circuits, high-frequency electronics (signal and noise), nonlinear modeling, and analysis of microwave devices and circuits.



Kambiz Afrooz was born in Baft, Iran, in 1983. He received the B.Sc. degree from the Shahid Bahonar University of Kerman, Kerman, Iran, in 2005, the M.Sc. degree from the Amirkabir University of Technology (Tehran Polytechnic), Tehran, Iran, in 2007, both in electrical engineering. He is currently working toward the Ph.D. degree in electrical engineering at Amirkabir University

of Technology. In May 2011, he joined the CIMITEC group, University Autònoma de Barcelona (UAB), Barcelona, Spain, as a Visiting Student. His current research interests include computer-aided design of active and passive microwave device and circuits, computational electromagnetic, modeling and simulation of high-speed interconnects, and metamaterial transmission lines. Mr. Afrooz is the recipient of the Electrical Engineering Department Outstanding Student Award in 2007.

